## **Product datasheet** Characteristics

# BMEP581020H

processor module M580 - Level 1 - Distributed Harsh



Price\*: 2,230.00 GBP



## Main

Range of product	Modicon M580
Product or component type	Processor module
Product specific application	For severe environments

## Complementary

Number of racks	4	— ⊱ <u>≩</u>
Local I/O processor capacity (discrete)	1024 I/O	
Local I/O processor capacity (analog)	256 I/O	
Number of application specific channel (local rack)	36	— cianote
Application specific I/O	Serial link Counter Accurate time stamping Motion control SSI encoder HART	and is not to be used for determining
Checks	Process control	
Control channels	Programmable loops	— ţ
Integrated connection type	1 Ethernet TCP/IP for service port 2 Ethernet TCP/IP for device network USB type mini B	
Number of distributed equipment	64	
Communication module processor capacity	2 Ethernet communication module 8 AS-Interface module	
Communication service	DIO scanner	— i
Memory description	Integrated RAM, 4 MB for program Integrated RAM, 384 kB for data Expandable flash, 4 GB for data storage Integrated RAM, 10 kB for system memory	- signature de la constante de
Application structure	1 cyclic/periodic master task 64 event tasks	

	1 periodic fast task 2 auxiliary tasks
Number of instructions per ms	7.5 Kinst/ms 65 % Boolean + 35 % fixed arithmetic 10 Kinst/ms 100 % Boolean
Current consumption	270 mA at 24 V DC
MTBF reliability	600000 H
Marking	CE

### **Environment**

Environment	
Vibration resistance	3 gn
Shock resistance	30 gn
Ambient air temperature for operation	-2570 °C
Ambient air temperature for storage	-4085 °C
Operating altitude	02000 m 20005000 m with derating factor
Relative humidity	595 % at 55 °C without condensation
IP degree of protection	IP20
Directives	2014/35/EU - low voltage directive 2014/30/EU - electromagnetic compatibility 2012/19/EU - WEEE directive
Standards	EN 61131-2 EN 61000-6-4 EN 61000-6-2 EN 61010-2-201
Protective treatment	Conformal coating
Environmental characteristic	Gas resistant class Gx Gas resistant class 3C4 Dust resistant class 3S4 Sand resistant class 3S4 Salt resistant level 2 Mold growth resistant class 3B2 Fungal spore resistant class 3B2
Product certifications	UL ATEX IEC-Ex CE Merchant Navy CSA RCM EAC
Supply	Internal power supply via rack
Status LED	1 LED (green)processor running (RUN): 1 LED (red)processor or system fault (ERR): 1 LED (red)I/O module fault (I/O): 1 LED (green)download in progress (DL): 1 LED (red)memory card or CPU flash fault (BACKUP): 1 LED (green/red)ETH MS (Ethernet port configuration status): 1 LED (green/red)Eth NS (Ethernet network status):
Product weight	0.849 kg

### Offer Sustainability

Green Premium product
REACh Declaration
Pro-active compliance (Product out of EU RoHS legal scope) EU RoHS Declaration
Yes
Yes
China RoHS declaration
End of Life Information
The product must be disposed on European Union markets following specific waste collection and never end up in rubbish bins

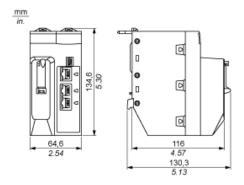
## Contractual warranty

Warranty 18 months

# Product datasheet Dimensions Drawings

# BMEP581020H

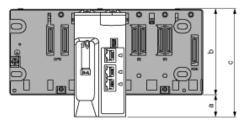
## CPU Module Only



# Product datasheet Dimensions Drawings

## BMEP581020H

#### Modules Mounted on Racks

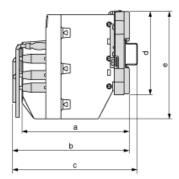


- a: additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c: the height of the main local rack, 134.6 mm (5.299 in.)

# Product datasheet **Dimensions Drawings**

## BMEP581020H

### Modules and Cables Mounted in an Enclosure



enclosure depth: 135 mm (5.315 in.) a:

b:

C:

wiring + module depth: > 146 mm (5.748 in.)
wiring + module + DIN rail depth: > 156 mm (6.142 in.)
rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.) d:

module height: 134.6 mm (5.299 in.) e: